

10-18-2002



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October 10, 2002

J1040 U.S. PTO  
10/268478  
10/16/02  
BRUSSELS

BY EXPRESS MAIL  
NO. EV126283239US

Commissioner of Patents  
BOX NEW APP FEE  
Washington, D.C. 20231

Re: Advanced Semiconductor Engineering, inc.  
Matter No. 400800  
Patent Application for: SUBSTRATE STRIP  
WITH SIDES HAVING FLANGES AND RECESSES

Dear Sir:

Please record the attached original document or copy thereof.

10-10-02

1. Name of conveying party(ies):

Kuang-Chun Chou  
Win-Chi Cheng

10/268478

2. Name and address of receiving party(ies):

Advanced Semiconductor Engineering, Inc.

Address: 26 Chin 3rd Road  
Nantze Export Processing Zone Kaoshiung  
Kaoshiung, Taiwan, R.O.C.

3. Nature of Conveyance: Assignment

Dates of execution: October 2, 2002

4. This Assignment is being filed together with a new application, the execution dates of which are: October 2, 2002

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WASHINGTON D.C. SAN FRANCISCO SEATTLE NEW YORK CHICAGO

5. Name and address of party to whom correspondence concerning document should be mailed:

Harold V. Stotland  
Seyfarth Shaw  
Suite 4200  
55 East Monroe Street  
Chicago, Illinois 60603-5803

6. Total number of applications involved: 1.
7. Total fee enclosed (37 CFR 1.21(h)): \$ 40.00
8. Please charge any additional fees or credit any overpayment to Deposit Account No. 19-1351.
9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Date: 10/10/02

  
Harold V. Stotland

Total Number of Pages Including Cover Sheet, Attachments and Document: 4

ASSIGNMENT

Title of Invention:   SUBSTRATE STRIP WITH SIDES HAVING FLANGES AND RECESSES

Assignee: Advanced Semiconductor Engineering, Inc.

[Company Name]

26 Chin 3<sup>rd</sup> Road, Nantze Export Processing Zone Kaoshiung,  
Kaoshiung, Taiwan, R.O.C.

[Address]

Taiwan, R.O.C.

[Place of Incorporation]

Name of Each Inventor  
and Assignor:

Date(s) of Execution of  
Patent Application:

Kuang-Chun Chou

\_\_\_\_\_

Win-Chi Cheng

\_\_\_\_\_

\_\_\_\_\_

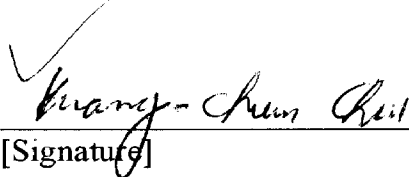
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We, the undersigned, for good and valuable considerations to us in hand paid, the receipt and sufficiency whereof are hereby acknowledged, have sold, assigned, conveyed and set over, and do hereby sell, assign, convey and set over unto the above-identified assignee (hereinafter "Assignee"), its successors and assigns, the entire right, title and interest in and to all subject matter invented or designed by us and disclosed in the above-identified application, and any divisions and continuations thereof and in and to all Letters Patent of the United States including any reissues and extensions thereof that may be obtained therefor, and the right, where such right can be legally exercised, in its own name to apply for and obtain Letters Patent, Inventor's Certificates, Utility Models and Designs, in countries foreign to the United States, including the full right to claim for any such application the benefits of the International Convention as fully and entirely as we could have done if the application had been in our names, and the entire interest in any Letters Patent, Inventor's Certificate, Utility Model or Design which may be granted on any such application in such foreign country; and we hereby authorize and request the Commissioner of Patents and Trademarks of the United States, and any official of any country or countries foreign to the United States whose duty it is to issue Letters Patent, Inventor's Certificates, Utility Models or Designs, on applications as aforesaid, to issue any and all Letters Patent, Inventor's Certificates, Utility Models and Designs that may be granted for said invention to ASSIGNEE, its successors and assigns.

We hereby authorize and request an attorney in Seyfarth Shaw to insert here in parentheses the serial number ( ) and the filing date ( ) of said application when known.

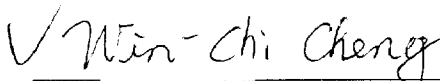
And for the above-named considerations, we hereby agree that we will, without additional compensation but without cost to us, promptly communicate to Assignee, its successors and assigns, any facts known to us respecting said invention whenever requested, and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing and reissue applications for Letters Patent and assignments thereof, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, as and when requested by them, in obtaining and enforcing proper patent protection for said invention or inventions and improvements in the United States.

Dated: 2 October 2002

  
\_\_\_\_\_  
[Signature]

Kuang-Chun Chou  
\_\_\_\_\_  
[Name Printed]  
26 Chin 3<sup>rd</sup> Road, Nantze Export Processing Zone  
Kaoshiung, Kaoshiung, Taiwan, R.O.C.  
\_\_\_\_\_  
[Residence and Post Office Address]

Dated: 2 October 2002

  
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[Signature]

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[Signature]

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